



# PRODUCT SPECIFICATION

## EC300P



Devanture Technologies  
(S) Pte. Ltd.

# Product Introduction



Industrial Grade

Remote O&M

Multi-interface

Secondary Dev

Cost-effective

The **EC series ARM industrial PC** are specifically designed for harsh industrial environments, featuring industrial-grade reliability (operating temperature: -40~85°C). They integrate rich interfaces (Ethernet/RS485/CAN, etc.) and multiple networking methods (4G/5G/Wi-Fi/Ethernet). They come with free remote management software and comprehensive SDK/documentation to facilitate quick deployment and customization.

Based on an optimized Linux system, the EC series is pre-installed with **Node-RED 4.0** and **NeuronEX-Lite**. **Node-RED** enables visual drag-and-drop programming for rapid business logic building, while **NeuronEX-Lite** as lightweight edge computing software supports millisecond-level device connectivity via multi-protocol compatibility. This "Dual-N" architecture seamlessly integrates development efficiency with professional data acquisition, enhancing the reliability of industrial IoT solutions.

# Product Specification

Model		EC300P
Core Configuration	CPU	RK3562J 4 × Cortex-A53@1.8GHz
	RAM	2G
	eMMC	16G
	OS	Linux
	GPU	Mali G52 2EE
	Computing Power	1TOPS
	SD Card	Micro SD Card Socket
	SSD	M.2 NVMe SSD Socket*
4G (Optional)	Module	Quectel - Cat.4 (4G)
	Supported Bands	LTE-FDD: B1/B3/B5/B8
		LTE-TDD: B34/B38/B39/B40/B41 WCDMA: B1/B5/B8 GSM: 900MHz/1800MHz
	Transmit Power	LTE-TDD: Class 3 (23 dBm ±2 dB)
LTE-FDD: Class 3 (23 dBm ±2 dB) WCDMA: Class 3 (24 dBm +1/-3 dB) PCS1900 8-PSK: Class E2 (26 dBm ±3 dB) DCS1800 8-PSK: Class E2 (26 dBm ±3 dB) EGSM900 8-PSK: Class E2 (27 dBm ±3 dB) GSM850 8-PSK: Class E2 (27 dBm ±3 dB) PCS1900: Class 1 (30 dBm ±2 dB) DCS1800: Class 1 (30 dBm ±2 dB) EGSM900: Class 4 (33 dBm ±2 dB) GSM850: Class 4 (33 dBm ±2 dB)		
Bandwidth (Max rates are theoretical)	LTE-FDD: Max 150Mbps (DL) / Max 50Mbps (UL) LTE-TDD: Max 130Mbps (DL) / Max 30Mbps (UL)	

\* Form Factor: M.2 (2280), Slot: M-KEY, Interface: PCIe 3.0 + NVMe



# Product Specification

5G (Optional)	Module	Quectel - 5G
	Supported Bands	5G NR SA: n1/n28/n41/n77/n78/n79 5G NR NSA: n41/n78/n79 LTE-FDD: B1/B2/B3/B5/B7/B8/B20/B28 LTE-TDD: B34/B38/B39/B40/B41 WCDMA: B1/B2/B5/B8
	Transmit Power	5G NR n41/n78/n79 HPUE: Class 2 (26 dBm +2/-3 dB) 5G NR n77/n78/n79: Class 3 (23 dBm +2/-3 dB) 5G NR n28: Class 3 (23 dBm +2/-2.5 dB) 5G NR n1/n41: Class 3 (23 dBm +2 dB) LTE B41 HPUE: Class 2 (26 dBm +2 dB) LTE: Class 3 (23 dBm +2 dB) WCDMA: Class 3 (23 dBm ±2 dB)
	Bandwidth (Max rates are theoretical)	NSA: 2.2 Gbps (DL) / 575 Mbps (UL) SA: 2 Gbps (DL) / 1 Gbps (UL) LTE: 600 Mbps (DL) / 150 Mbps (UL)
Wi-Fi	Wireless Standard	802.11 a/b/g/n/ac/ax (Wi-Fi6)
	Operating Frequency Band	Dual-band (2.4GHz + 5GHz)
	Operating Mode	STA + AP + Wi-Fi Direct modes
	Maximum Data Rate	600.4 Mbps (20/40/80MHz bandwidth)
	Technical Support	STBC, Beamforming, Wi-Fi 6 TWT, LDPC, MU-MIMO, OFDMA
	Security Encryption	WEP/WPA/WPA2/WPA3-SAE Personal, MFP
Ethernet Ports	WAN	1 × 10M/100M/1000M Auto-Negotiation
	LAN	2 Ports
USB	2.0	1 Port (Debugging Interface)
	Type-C	1 Port
RS485	Interface Quantity	A, B
	Connection Terminals	2400~921600bps
	Baud Rate	7, 8
	Data Bits	1, 2
	Stop Bits	NONE (No Parity), EVEN (Even Parity), ODD (Odd Parity)
	Parity Protection	Anti-static, Anti-surge

# Product Specification

Indicator Lights	LED	6 pcs (4 user-programmable)
Multimedia	Touch Screen	Display: 10.1" 16:9 TFT LCD, BOE original industrial-grade screen LCD Viewing Angle: 85°/85°/85°/85°(T/B/L/R) Resolution: 1280(H)×800(V) Color: 16.7M Brightness: 400cd/m <sup>2</sup> Backlight: LED LCD Lifespan: >50000h Touch Technology: 10-point capacitive
	HDMI	1 Port
	3.5mm Audio Jack	1 Port
Electrical Parameters	Certification	CE
	Operating Voltage	9~36V
	Operating Current	570mA/12V
Environmental Parameters	Operating Temperature	-40~85°C
	Storage Temperature	-40~85°C
	Operating Humidity	0~95%RH (non-condensing)
	Storage Humidity	0~95%RH (non-condensing)
Mechanical Parameters	Overall Dimensions	300×203×37.4mm
	Enclosure Material	Galvanized Alloy
	Installation Method	Embedded Installation
	Heat Dissipation	Passive Cooling
	Reset Button	Press & hold for 10s to reset
EMC	Electrostatic Discharge (ESD)	Air Discharge: Level 3 ±8KV
	Surge (SURGE)	Contact Discharge: Level 2 ±4KV Level 2 ±1KV
	Electrical Fast Transient (EFT)	Level 2 ±1KV
	Node-RED	
Software Features	NeuronEX	Pre-installed (Node-RED 4.0)
	Web Configuration	Pre-installed (NeuronEX-Lite)
	Secondary Development	Pre-installed (FUXA)
	Open System	Supported
		Supported

# Wiring Instruction



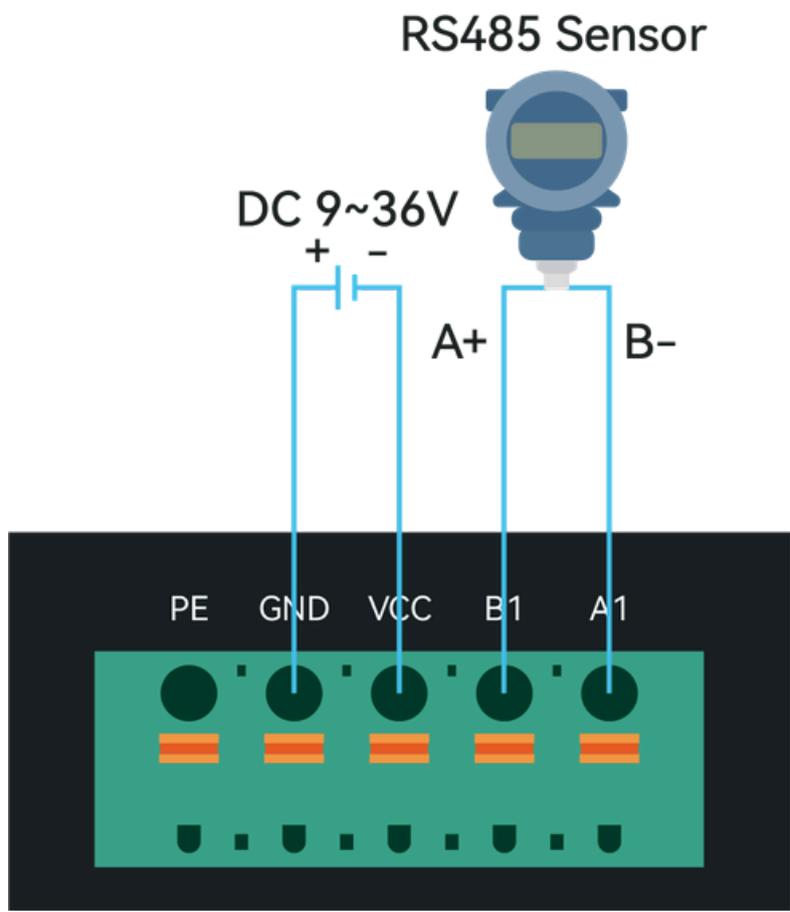
Interface Identification Diagram - 1



Interface Identification Diagram - 2



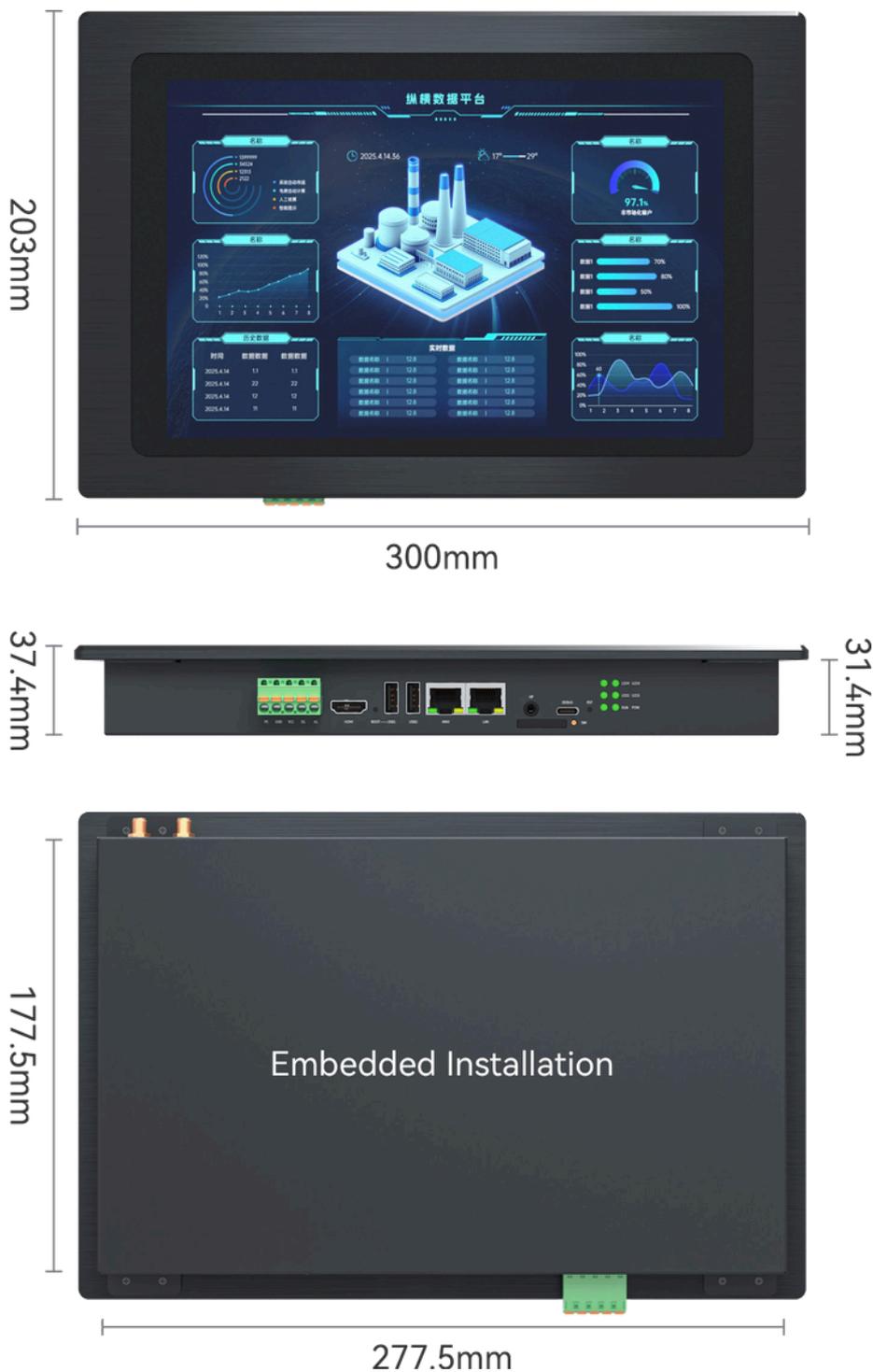
# Wiring Instruction



Power Supply & RS485 Wiring Diagram



## Installation Instruction

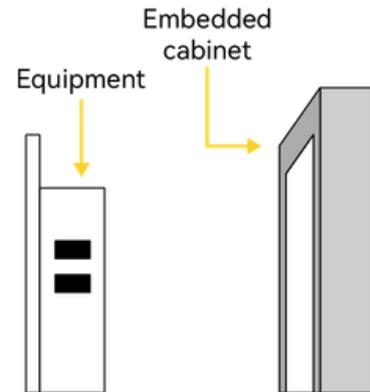


Product Size

## Installation Instruction

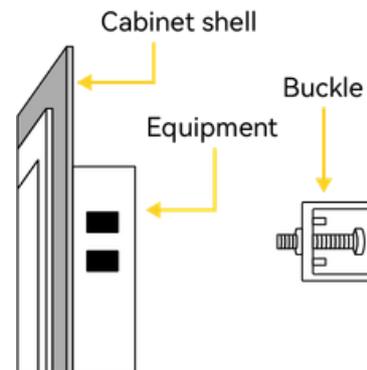
### Step 1.

Before installation, it is necessary to open the corresponding installation hole size, which is slightly larger than the equipment.



### Step 2.

Place the equipment in the reserved installation holes.

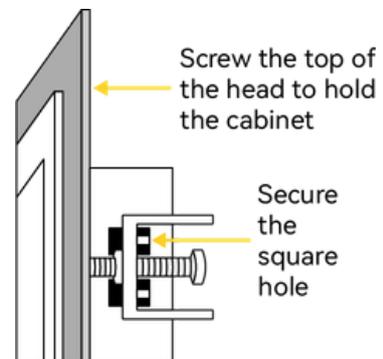


### Step 3.

There are two square holes on each side of the device.

fasten one end of the square hole, Hold the buckled screw head against the cabinet and tighten the screws.

The other three places are the same.



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